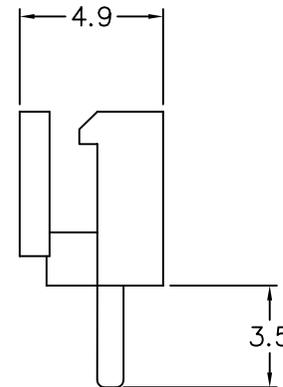
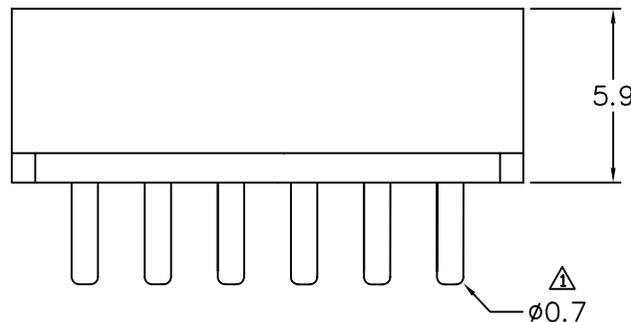
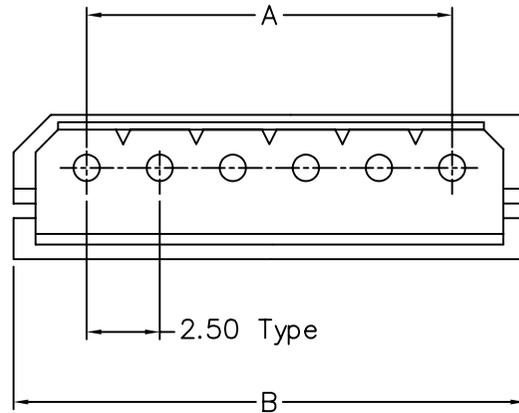


P.C Board Layout



SPECIFICATION:

. Current Rating:

AWG	22	24	26	28
Amp.	3.0	2.5	2.0	1.5

- . Voltage Rating: AC DC 250V
- . Withstanding Voltage: AC1000V /minute
- . Contact Resistance: Initial Value/10mΩ max.
After Environmental Testing/20mΩ max.
- . Insulation Resistance: 1,000MΩ min.
- . Temperature Range: -40°C To +105°C
- . Applicable PC Board Thickness: 0.8-1.6mm
- . Wafer
- . Poles: 2-15
- . Material: Post: Brass Tin/Plated
Base: Nylon 66, UL94V-0 Natural
- . Q'ty: 500, 1000 PCS/Bag

Part No.	Dimension: mm	
	A	B
MW02D	2.5	7.5
MW03D	5.0	10.0
MW04D	7.5	12.5
MW05D	10.0	15.0
MW06D	12.5	17.5
MW07D	15.0	20.0
MW08D	17.5	22.5
MW09D	20.0	25.0
MW10D	22.5	27.5
MW11D	25.0	30.0
MW12D	27.5	32.5
MW13D	30.0	35.0
MW14D	32.5	37.5
MW15D	35.0	40.0



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AUK CONTRACTORS CO., LTD.

CATEGORY	Wafer	APPROVED BY	MEI
PART No.	MWXXD	CHECKED BY	BECKY
DRAWING No.	MWXXD	DRAWING BY	LXH
SCALE	NONE	REV.	A1

UNLESS OTHERWISE SPECIFIED TOLERANCES ARE
.X ±0.25
.XX ±0.15
AWG. ±2°

NO.	REV.	REVISIONS	CHK	DATE
△	A1	Modify Specification	BECKY	2004/02/24
△	A1	Modify Tolerances	BECKY	2004/02/24
△	A1	ø1.2 → ø0.90 ^{+0.10} / _{-0.00}	BECKY	2004/02/24
△	A1	2.5 Type → 2.5±0.05 Type	BECKY	2004/02/24
△	A1	Add. ø0.7	BECKY	2004/02/24